Vertexing Analysis: L1L2, L2L2, and 2016 Data

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Dividing the Vertex Analysis into Categories

Vertex analysis is divided into mutually exclusive categories based on which particles hit which layers

L1L2/L2L2 capture the longer-lived A's, improve low ϵ reach







- 1. Hit inefficiencies (not present in MC!)
- 2. Large scatters in the dead silicon into the active region
- Wab conversion in dead silicon and large scatter into the active region



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- 4. Double large scatter in the dead silicon (L2L2)



- Hit inefficiencies (not present 1. in MC!)
- 2. Large scatters in the dead silicon into the active region
- Wab conversion in dead 3 silicon and large scatter into the active region
- Double large scatter in the 4. dead silicon (L2L2)



- 1. Hit inefficiencies (not present in MC!)
- 2. Large scatters in the dead silicon into the active region
- Wab conversion in dead silicon and large scatter into the active region
- 4. Double large scatter in the dead silicon (L2L2)

Tridents produced in Layer 1 silicon dead layers!! (L2L2 events)

(or some combination of all of these, or bad tracks/vertex, or hits from other particles, or something I didn't think of about)

Developing the Necessary Tools

Adding necessary truth information to the analysis (Matt S., Takashi, Jeremy)

Physics info, Ecal info, and SVT info (both active and **inactive layers**)

Use SVT info to compute scattering angles



Cuts

"Nominal" Vertexing Cuts:

isPair1; layer cuts; matchChi2<10;trackT - CIT <4; clT diff<2; eleCIY*posCIY<0; bscChisq<10; bscChisq-uncChisq<5; trkChisq<30; abs(eleP-posP)/(eleP+posP)<0.5;e leP<ebeam*0.75; uncP<ebeam*1.15;r adiative; isolation cuts

(These don't change the result much)

Exploring Cuts: Track Extrapolation, Kinks, Target Projection, Beamspot Projection, and Silicon (for L2L2 only)

L1L2 Cutflow



L1L2 A' Cutflow

eff

0.009

0.008

0.007

0.006 A.U.

0.005

0.004

0.003

0.002

0.001

0

20

40

Efficiency A' 0.0399595959596



L1L2 Nominal Cuts



L1L2 Without Track Extrapolation Cuts

Events removed by track extrapolation



L1L2 With Extrapolation Cuts



L1L2 Target Projection Cuts

Events removed by target projection cuts



L1L2 Kink Cuts

Events removed by kink cuts



Current State of L1L2

Rates of Data/MC do not agree for L1L2



Current State of L1L2







Large Scatters in L1L2

Difference in scattering angle of e+e- away from beam



Remaining L1L2 Background

Contaminated tracks have at least one hit not associated with matched tracks



L2L2 Cutflow



A' L2L2 Cutflow



L2L2 Nominal Cuts



L2L2 Track Extrapolation Cuts

Events removed by track extrapolation



L2L2 After Track Extrapolation Cuts



L2L2 After Track Extrapolation Cuts



L2L2 Very High Z Events

Xsec: Si/W ~ 0.009; Nevents Si/W ~ 0.0003



L2L2 Tridents Produced at Silicon

Fit sum of 2 gaussians (for 2 sensors) in top and bottom and cut at 3σ



L2L2 Target Projection Cut

Events removed by target projection cuts



L2L2 Kink Cuts

Events removed by kink cuts



Current State of L2L2

Rates of data/MC for L2L2 do not agree



Current State of L2L2

Rates of data/MC for L2L2 do not agree



10% 2016 Pass1 Data L1L1 Preliminary

2016 Nominal L1L1 Cuts



Conclusion

L1L2/L2L2 analysis are an ongoing process, but have made significant progress due to newly developed truth MC.

Rates of Data/MC do not agree for L1L2 and L2L2. Why? Do we need more (biased) MC? (however shapes agree)

There are specific backgrounds in both L1L2/L2L2 that are not well understood that need more work (aim at the background events in A' habitable zone)

L2L2 tridents produced at the silicon needs to be simulated (Takashi) and optimized

Can we (do we want to) include this with the L1L1 result for iChep?

L1L2 Beamspot Projection Cuts



tweakPass6



